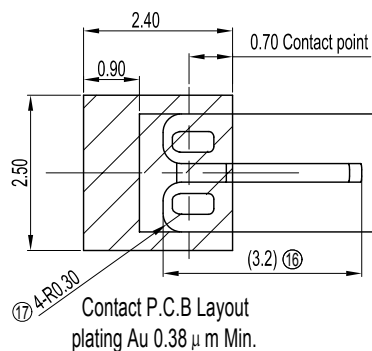
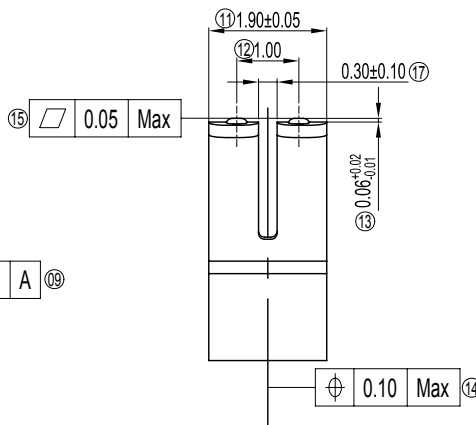
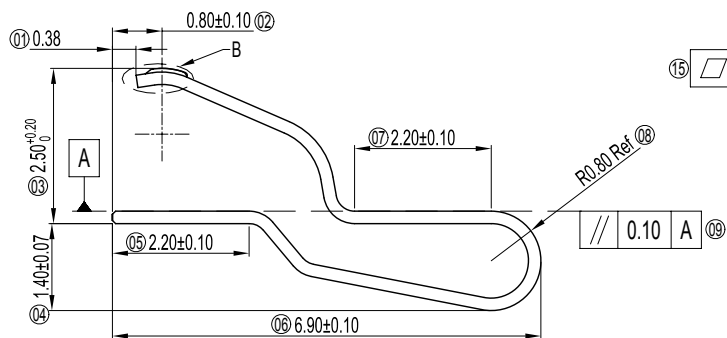
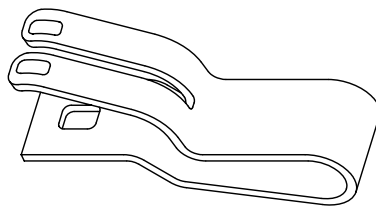
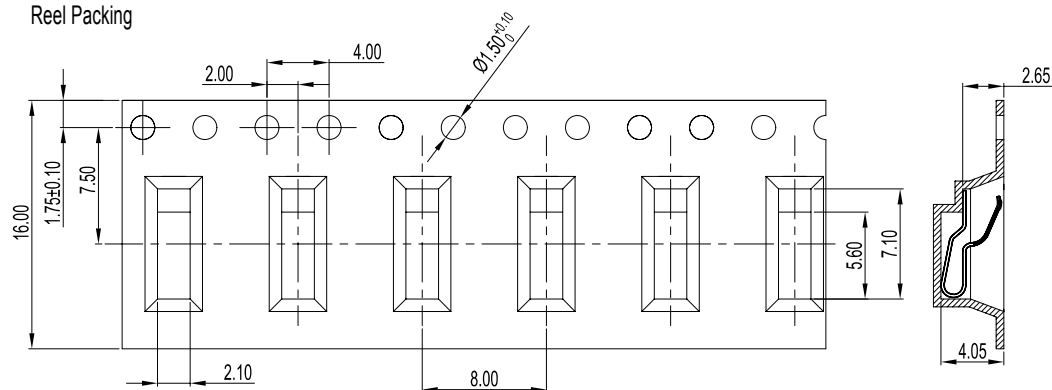


SOLDER P.C.B LAYOUT
TOP VIEW



Contact P.C.B Layout
plating Au 0.38 μm Min.

Reel Packing



Performance characteristics:

1.Main body part material

Contact terminal: Copper Alloy, 1.27 ~ 2 μm Ni under plated,
Contact plating Au 0.38 μm Min. ,Other plating Au 0.075 ~ 0.125 μm.

2.Electrical requirements:

Current rating: 7 A

Voltage rating: 60 V DC

Contact resistance: ≤ 3 mΩ

3.Environment specification

Working temperature: -50℃ ~ +110℃

4.Packing & storing

Method of packing: Reel

Storing condition: temperature of -10℃ ~ +40℃
below 80% relative humidity

5.Style of installation: SMT

6.To prevent the pollution of the environment product info
RoHS agreement:In line with the european union RoHS.

Unless otherwise specified tolerance:

X.	± 0.50	X.°	± 3°
.X	± 0.38	.X°	± 2°
.XX	± 0.25		

Mark	NO.	File NO.	Signature	Date
DRAW		An.Cheng		2015-06-17
CHK				
MAN				
STD				
APP				

SMT Spring
(Customer: HUAWEI)

19163025

SL0.1916.016

Projection	Rev.	Weight	Scale
	A0		

All Dimensions in mm Sheet 1 of 1

